Holding the "Bond Market Group" Meeting

As announced in the "Expanding Forums for Dialogue with Market Participants" released on January 28, 2015, the Financial Markets Department of the Bank will hold the first round of the "Bond Market Group" meetings in the following manner.

In order to make best use of the "Bond Market Survey" which started this February and facilitate more attentive dialogue with bond market participants, the Financial Markets Department will divide participants into relatively small groups and hold the meeting with each group.

1. Date Group 1 June 11 at 6:00 p.m. Group 2 June 12 at 4:00 p.m.

Group 3 June 12 at 6:00 p.m.

2. Place The Head Office of the Bank of Japan

3. Participants

- Persons in charge of bond market issues in financial institutions, participating in the "Bond Market Survey" or the "Meeting with Market Participants"
- Director-General of the Financial Markets Department, Head of Coordination and Market Analysis Division, Head of Market Operations Division, Head of Market Infrastructure Division

4. Topic

The Bank will explain (1) the results of the "Bond Market Survey," (2) liquidity in the JGB Market, and (3) recent developments in the financial markets and market operations. The Bank will also exchange views with participants on these topics.

For further information, please contact the Bank of Japan at the following e-mail address. Market Infrastructure Division at the Financial Markets Department: post.fmd29@boj.or.jp